

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Charles W.C. Lin	10/25/2010
Chia-Chung Wang	10/25/2010
RECEIVING PARTY DATA	
Name:	Bridge Semiconductor Corporation
Street Address:	3rd Floor, 157 Li-Te Road, Peitou District
City:	Taipei
State/Country:	TAIWAN
Postal Code:	112
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12911729
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ATTORNEY DOCKET NUMBER:	BDG072
NAME OF SUBMITTER:	David M. Sigmond
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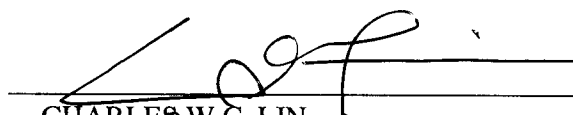
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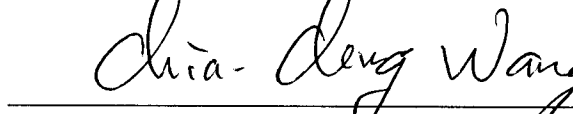
WHEREAS, we, CHARLES W.C. LIN of Singapore and CHIA-CHUNG WANG of Taiwan have invented a certain new and useful invention entitled SEMICONDUCTOR CHIP ASSEMBLY WITH BUMP/BASE HEAT SPREADER AND CAVITY IN BUMP, for which an application for Letters Patent of the United States has been prepared for filing, said application being identified as Attorney Docket No. BDG072;

NOW THEREFORE, be it known that we, the said inventors, for and in consideration of certain good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, at the request of the assignee do sell, assign and transfer unto said assignee, BRIDGE SEMICONDUCTOR CORPORATION, a Taiwan Corporation having a place of business at 3rd Floor, 157 Li-Te Road, Peitou District, Taipei, Taiwan 112, its successors, legal representatives and assigns, the aforesaid application for the territory of the United States of America and all continuation, divisional, continuation-in-part and reissue applications, all patent applications in foreign countries, all applications pursuant to the Patent Cooperation Treaty, and all applications for extension filed or to be filed for the invention, and all Letters Patent, Invention Registrations, Utility Models, Extensions or Reissues, Reexaminations and other patent rights, obtained for the invention in the United States or any other country; we also assign any right, title or interest in and to the invention which has not already been transferred to the assignee; we warrant that we have made no assignment of the invention, application or patent therefor to a party other than BRIDGE SEMICONDUCTOR CORPORATION and we are under no obligation to make and shall not make any assignment of the invention, application, or patent therefor to any other party; and we further agree to cooperate with the assignee hereunder in obtaining, sustaining and enforcing of any and all such Letters Patent and patent rights and in confirming the assignee's exclusive ownership of the invention, without further consideration, but at the expense of said assignee.

The Commissioner of Patents is hereby authorized and requested to issue the Letters Patent solely in accordance with the terms of this Assignment to BRIDGE SEMICONDUCTOR CORPORATION, its successors, legal representatives and assigns, as the assignee of the entire right, title and interest therein.

IN WITNESS WHEREOF, the parties hereto have executed this Assignment as of the date indicated hereunder.

Date: Oct. 25, 2010 By: 
CHARLES W.C. LIN

Date: Oct. 25, 2010 By: 
CHIA-CHUNG WANG

099士院認005
案號 Case No. 001434 日期 Date: OCT 25 2010
本文件 林文強 王忠 之簽名或蓋章，在臺灣士林地方法院公證處認證。
Attested at the Notary Public Office of Taiwan Shihlin District Court, R.O.C., that the signature(s)/seal(s) of CHARLES W.C. LIN & CHIA-CHUNG WANG in this document is/are authentic.
Notary Public
Lien, Meng-han

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